

# **EVERLIGHT ELECTRONICS CO., LTD.**

# **Technical Data Sheet** 0603 Package Chip LED (0.4mm Height)

#### 19-217/G7C-AN1P2/3T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS complaint version

#### **Descriptions**

- The 19-217 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Applications**

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### **Device Selection Guide**

D (N	Chip	F 14 1 G 1	Resin Color	
Part No.	Material	Emitted Color		
19-217/G7C-AN1P2/3T	AlGaInP	Brilliant Yellow Green	Water Clear	

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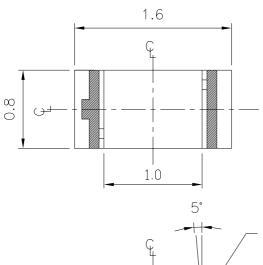
Device No: DSE-0000541

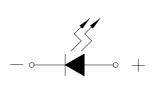
http://www.everlight.com Prepared date:15-Dec.-2008

Prepared by: Changhong Pan

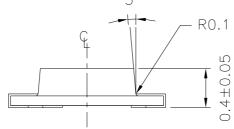
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### **Package Outline Dimensions**

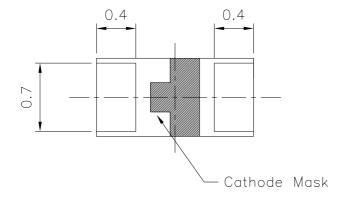


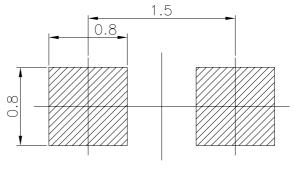






For reflow soldering (propose)





**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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# 19-217/G7C-AN1P2/3T

### **Absolute Maximum Ratings (Ta=25℃)**

Parameter	Symbol	Rating	Unit	
Reverse Voltage	Vr	5	V	
Forward Current	${ m I_F}$	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	60	mA	
Power Dissipation	Pd	60	mW	
Electrostatic Discharge(HBM)	ESD	2000	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	<b>-</b> 40 ∼ +90	$^{\circ}\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec.  Hand Soldering: 350 °C for 3 sec.		

## Electro-Optical Characteristics (Ta=25 $^{\circ}$ C)

			<u> </u>			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	28.5		72.0	mcd	
Viewing Angle	2 \theta 1/2		120		deg	
Peak Wavelength	λр		575		nm	
Dominant Wavelength	λd	569.5		577.5	nm	$I_F=20\text{mA}$
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	VF	1.7	2.0	2.4	V	
Reverse Current	Ir			10	$\mu$ A	V <sub>R</sub> =5V

#### **Notes:**

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm

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### 19-217/G7C-AN1P2/3T

Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
A	C16	569.5	571.5		I <sub>F</sub> =20mA
	C17	571.5	573.5	nm	
	C18	573.5	575.5		
	C19	575.5	577.5		

#### **Bin Range Of Luminous Intensity**

		- J		
Bin	Min	Max	Unit	Condition
N1	28.5	36.0		
N2	36.0	45.0	mcd	I <sub>F</sub> =20mA
P1	45.0	57.0		
P2	57.0	72.0		

#### **Notes:**

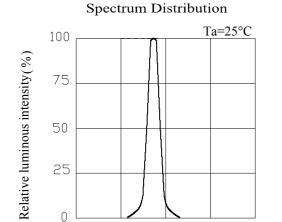
- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm

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### **Typical Electro-Optical Characteristics Curves**



500

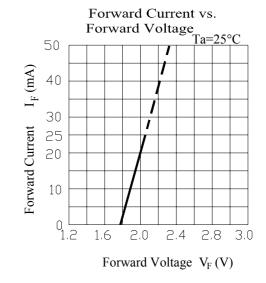
550

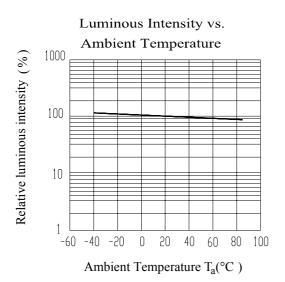
Wavelength λ(nm)

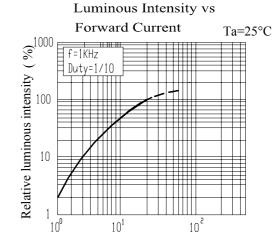
600

650

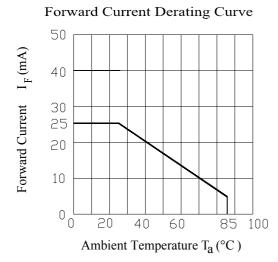
700

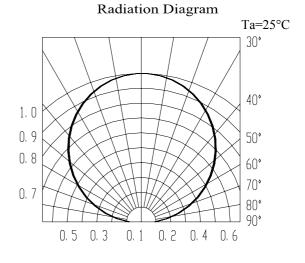






Forward Current  $I_F$  (mA)





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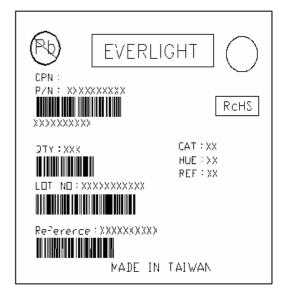
#### 19-217/G7C-AN1P2/3T

#### Label explanation

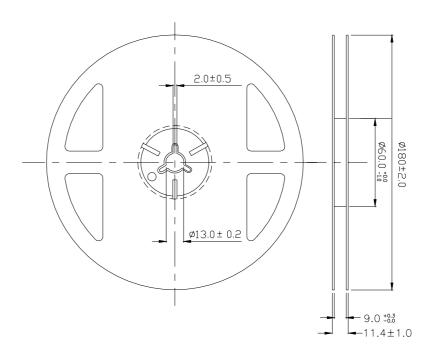
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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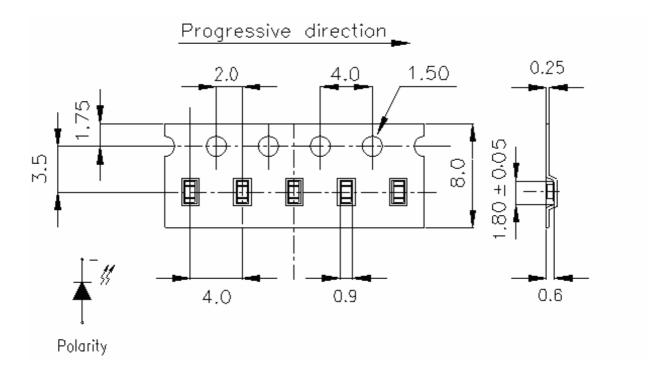
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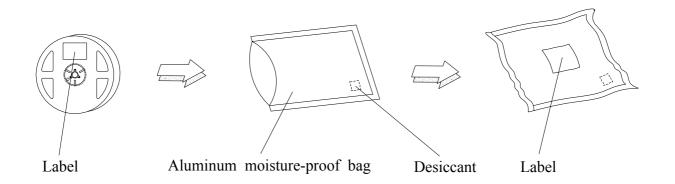
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#### Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



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#### **Moisture Resistant Packaging**



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### 19-217/G7C-AN1P2/3T

#### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H:+100°C 15min ∫ 5 min L:-40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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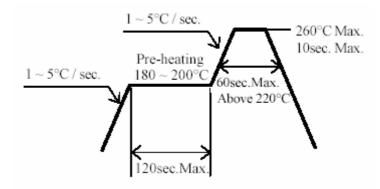
#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

  Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
  - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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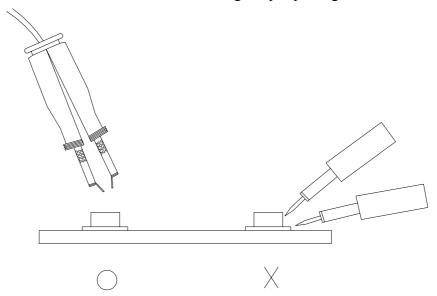
#### 4. Soldering Iron

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Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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## 单击下面可查看定价,库存,交付和生命周期等信息

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